

Surface-mount service distribution board with three-point turn-lock, W = 600 mm, H = 760 mm



Part no. BP-0-600/7 Article no. 100964

Design verification as per IEC/EN 61439

Heat dissipation, at an ambient temperature of 35°C, delta T: 20 degrees, calculated as per IEC 60890 Individual enclosure for wall mounting Pv C0 Starting enclosure for wall mounting Pv C0 Middle enclosure for wall mounting Pv C0 62 Heat dissipation, at an ambient temperature of 35°C, delta T: 35 degrees, calculated as per IEC 60890 Individual enclosure for wall mounting Pv C0 141 Starting enclosure for wall mounting Pv C0 133 Middle enclosure for wall mounting Pv C0 125	Design vernication as per icc/civ 01453			
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10.12 Electromagnetic compatibility Is the panel builder's responsibility.	10.10 Temperature rise			
	10.11 Short-circuit rating			Is the panel builder's responsibility.
10.13 Mechanical function Meets the product standard's requirements.	10.12 Electromagnetic compatibility			Is the panel builder's responsibility.
	10.13 Mechanical function			Meets the product standard's requirements.

Technical data ETIM 6.0

Distribution	hnarde	(EG000023) /	Small	distribution	hoard	(FC000214)
Distribution	Duarus	(LUUUUUZJ)/	Jillali	uistribution	Duaru	(LC000214)

Electric engineering, automation, process control engineering / Electrical installation, device / Electrical distribution system (incl. small distribution board) / Small distribution board (ecl@ss8.1-27-14-24-09 [ACN387008])

(ecl@ss8.1-27-14-24-09 [ACN387008])				
Mounting method	Surface mounting			
Number of rows	5			
Width in number of modular spacings	24			
Type of cover	Door			
Cover model	Closed			
Transparent cover/door	No			
Material housing	Steel			

Height	mm	760
Width	mm	600
Depth	mm	262.5
Built-in depth	mm	0
Internal depth	mm	257.5
DIN-rail		Yes
With mounting plate		No
Extension possible		Yes
EMC-version		No
Colour		Grey
RAL-number		7035
Degree of protection (IP)		IP30
With lock		No